

REMARKS

It is believed that the enclosed new drawings obviate the examiner's objection, while also adding reference numerals inadvertently omitted from Figures 1 and 2. Minor amendments have been made to the specification to reflect the added illustration in Figure 2. None of these changes involves the addition of new matter.

It is respectfully submitted that the examiner's claim rejections under 35 USC §§ 102 and 103 are simply not supported by the disclosure in the U.S. Patent No. 4,125,739 (Bow).

In Bow's Figure 2, the composite layers 24 and 28 are adhesives, not films, and the layer 26 is a "bond control layer", not an adhesive. The bond control layer 26 is strippably adhered to the adhesive layer 24, the latter being firmly bonded to the outer metallic layer 12.

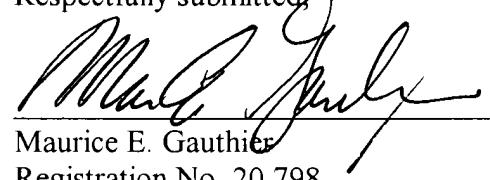
The entire thrust of the Bow disclosure is to allow the bond layer 26 to separate from the adhesive 24 without disturbing the adhesive 24 as a protective coating on the metallic layer 12.

Thus, Bow lacks any disclosure or suggestions of the present invention, which in its most basic form as show in Figure 1, includes a flexible electronically conductive layer 16 bonded to the upper surface 12a of a first film 12, with the lower surface 12b of the film 12 being adhered to the upper surface 14a of a second film 14 by an adhesive interlayer 18 having elastic properties sufficient to accommodate relative movement between the films 12, 14 occasioned by flexure of the composite.

The other references of record also lack any disclosure or suggestion of this unique combination. Accordingly, it is now believed that this application is in condition for allowance.

Attached hereto is a reproduction of the amended portions of the specification and claims, with brackets and underlining to highlight the changes made.

Respectfully submitted,



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**AMENDED PORTIONS OF
SPECIFICATION AND CLAIMS WITH
BRACKETS AND UNDERLINING**

IN THE SPECIFICATION

Line 15 of page 2:

--Figure 2 is an exploded view of the composite shown in Figure 1, with the addition of an optional second adhesive for securing the conductive layer to the upper surface of the first film.--

Lines 14-16 of page 5:

--A flexible electrically conductive layer 16 is applied to the upper surface 12a of film 12, and an adhesive interlayer 18 adheres the lower surface 12b of film 12 to the upper surface 14a of film 14. Figure 2 additionally shows an optional second adhesive for securing the conductive layer 16 to the upper surface 12a of film 12.--

IN THE CLAIMS

Claim 11:

(Amended) The composite of claims 1 or 2 wherein the polymeric materials of said first and second films are selected from the group consisting of polyesters, polyamides, polyimides, polyurethanes, polyethylenesulfones, polybutenes, and derivatives, polycarbonates, polystyrene[], (])and copolymers thereof containing styrene[]], polyethylene and linear polyethylene [(linear)], polyethyleneketones, polyacrylates [(])including methacrylates[]], rigid PVC and copolymers thereof [(and copolymers)].